



Dimensions

Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	2.8mm +/-0.3mm
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
K	1.8mm TYP

Packaging Specifications

Packaging	T&R, 330mm
Packaging Quantity	2800

General Information

Dielectric	MnO ₂ Tantalum
Style	SMD Chip
Description	SMD, Molded, Low ESR, Surge Robust
Features	Low ESR, Surge Robust
RoHS	Yes
Termination	Tin
AEC-Q200	No
Notes	Obsolete. Old Part Number [Obsolete] Was B45016D2276K227.

Specifications

Capacitance	220 uF
Capacitance Tolerance	10%
Voltage DC	16 VDC (85C), 10.72 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	12%
Failure Rate	N/A
ESR	0.22 Ohms (100kHz)
Ripple Current	830 mAmps (25C), 747 mAmps (85C), 332 mAmps (125C)
Leakage Current	35.2 uA